

Macaron N Series

MSN09

NFC Controller Module with Integrated Antenna

Datasheet Version 1.1

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FEDERAL COMMUNICATIONS COMMISSION INTERFERENCE STATEMENT

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

	Reorient or relocate the receiving antenna.
	Increase the separation between the equipment and receiver.
	Connect the equipment into an outlet on a circuit different from that to which the receiver is
	connected.
	Consult the dealer or an experienced radio/ TV technician for help.
This	device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions:
	This device may not cause harmful interference.
	This device must accept any interference received, including interference that may cause
	undesired operation.

CAUTION:

Any changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) this device may not cause harmful interference, and
- (2) this device must accept any interference received, including interference that may cause undesired operation.

Information for the OEMs and Integrators

The following statement must be included with all versions of this document supplied to an OEM or integrator, but should not be distributed to the end user.

- 1) This device is intended for OEM integrators only.
- 2) Please see the full Grant of Equipment document for other restrictions.

End Product Labeling

This transmitter module is authorized only for use in device where the antenna may be installed such that 20cm may be maintained between the antenna and users. The final end product must be labeled in a visible area with the following: "Contains FCC ID: 2AAYI-MSN09" and "Contains IC: 11378A-MSN09"



Canadian Compliance Statement

This device complies with Industry Canada license-exempt RSS standard(s). Operation is subject to the following two conditions:

- ☐ This device may not cause interference, and
- This device must accept any interference, including interference that may cause undesired operation of the device.

Cet appareil est conforme aux norms CNR exemptes de licence d'Industrie Canada. Le fonctionnement est soumis aux deux conditions suivantes:

- cet appareil ne doit pas provoquer d'interférences et
- cet appareil doit accepter toute interférence, y compris celles susceptibles de provoquer un fonctionnement non souhaité de l'appareil.

經型式認證合格之低功率射頻電機,非經許可,公司、商號或使用者均不得擅自變更頻率、加大功率或變更原設計之特性及功能。 低功率射頻電機之使用不得影響飛航安全及干擾合法通信; 經發現有干擾現象時,應立即停用,並改善至無干擾時方得繼續使用。前項合法通信,指依電信法規定作業之無線電通信。低功率射頻電機須忍受合法通信或工業、科學及醫療用電波輻射性電機設備之干擾。

本模組於取得認證後將依規定於模組本體標示審驗合格標籤,並要求最終產品平台廠商(OEM Integrator)於最終產品平台(End Product)上標示"本產品內含射頻模組,其 NCC 型式認證號碼為: 《CCXXxxYYyyyZzw"



Revision History

This section describes the changes that were implemented in this document. The changes are listed by revision, starting with the most current publication.

Revision 1.0

A Rule

A Rule Revision 1.0 of this datasheet was published in December 2015. This was the first publication



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1 Introduction

This document consists of descriptions and specifications for both functional and physical aspects of the MSN09 NFC reader / writer module.

In addition to the datasheet, Smart Approach maintains and extensive device-specific library of support and collateral materials that you may find useful in your application. Depending upon the Smart Approach device, this library may include:

- Presentations highlighting the operational features and specifications of the device to assist in developing your own product road map.
- Shrait Approach Application notes that provide detailed descriptions of the use of the particular Smart



Product Overview

MSN09 is full featured NFC controllers designed for integration in portable equipment. It is optimized for low power consumption with fully host controllable power states and for small footprint for portable equipment applications.

The module's compact, flexible design with and exposed pad is optimal for size-sensitive applications, assures robust performance.

The following illustration shows a high-level, generic view of a MSN09 application.

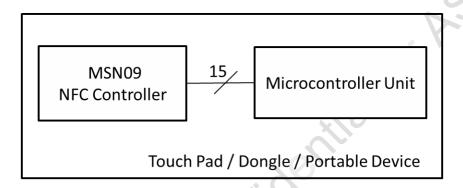


Figure 1 Typical Application

2.1 Features

This section Tables key aspects of the MSN09 module functionality and design that distinguish it from similar products:

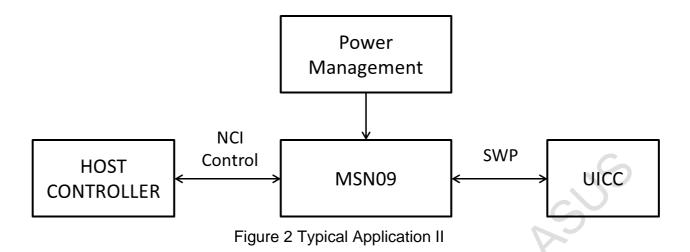
- NXP NPC100 NFC Controller
- Full featured NFC controller industry's low power consumption.
- Compliant with ISO/IEC 14443 A/B
- Compliant with 15693/18092
- Antenna pairing could be customized
- I²C interface
- The maximum of thickness is 1.5 mm.

2.2 Application

Suggested applications for the MSN09 module include:

- NFC writer NFC reader
- NFC peer to peer controller
- NFC payment
- NFC identification П





MSN09 can be connected on a host controller through I²C-bus interfaces. The logical interface towards the host base band is NCI-compliant with additional command set for SA specific product features. MSN09 can be connected to a UICC through an SWP interface. The SWP physical interface is compliant with ETSI/SCP SWP and HCI.

Moreover, MSN09 provides flexible and integrated power management unit in order to preserve energy supporting Powered by the Field and Power Off mode. It also allows various power schemes for the UICC.



3 Functional Descriptions

This section provides detailed information about how MSN09 module works, what configurations and operational features are available.

The following illustration shows the primary functional blocks of MSN09 module.

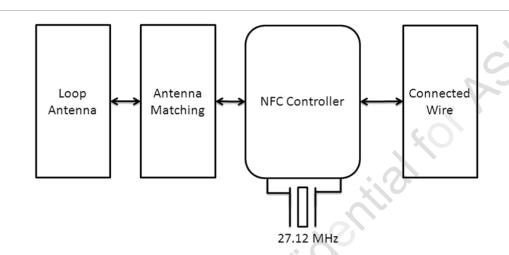


Figure 3 Module Block Diagram

Loop Antenna is Smart Approach customize solution, Antenna size of MSN09 is 40mm x 50 mm. Antenna matching is also a customize solution. NFC controller includes NXP NPC100 chipset, and has an I²C control interface through the connector to mother board.



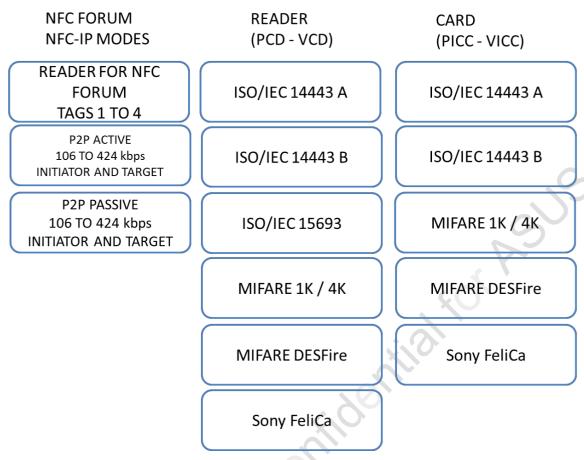


Figure 4 Transmission Modes

For contactless card functionality, MSN09 can act autonomously if previously configured by the host in such a manner. PICC functionality can be supported without device being turned on or even with battery removed.

3.1 Communication overview for ISO/IEC 14443A / MIFARE Controller

The contactless coprocessor and the on-chip CPU of MSN09 handle the complete ISO/IEC 14443A/MIFARE RF-protocol, nevertheless a dedicated external host has to handle the application layer communication.



4 Electrical Specifications

This section provides the DC characteristics, AC characteristics, recommended operating conditions. It includes information on the various timing functions of the module.

Pin Description

The following Table shows the pin description for MSN09 module.

The connection ground is internally connected and should be connected to GND on the main board as well.

Table 1 Module Pin Description

PIN No.	Name	Description	Power Reference	P/I/O
1	V_{BAT}	+3.3V power supply input	3.3V	Р
2	MOD_GND	Module Ground	GND	Р
3	SWP	SWP data line to UICC/SIM, Input / Output	PMUVcc	I/O
4	RFU	Unused pin could be floating	-	-
5	IRQ	Interrupt to host, High: Interrupt; Low: Normal	VDD_IO	0
6	PMUV _{CC}	Power supply to UICC/SIM, input, + 1.8V	1.8V	Р
7	I ² C_SDA	I ² C Data Line (Typical I2C speed: 400KHz)	VDD_IO	I/O
8	I ² C_SCL	I ² C Clock (Typical I2C speed: 400KHz)	VDD_IO	I
9	MOD_GND	Module Ground	GND	Р
10	V_{EN}	Wake up the module from standby mode or reset the module	V_{BAT}	I
11	DWL_REQ	Firmware download control: Active High	VDD_IO	I
12	SIMV _{CC}	The power rail used to power UICC / SIM, output pin	PMUVcc	P(O)
13	V_{BAT}	+3.3V Power Supply	3.3V	Р
14	VDD_IO	+1.8V or +3.3V for host IO reference voltage	1.8V/3.3V	Р
15	MOD_GND	Module Ground	GND	Р



I²C Address

MSN09 I²C 7bit address is defined to 0x28. To write data, this module is addressed using 0x50, to read data, this module is addressed using 0x51.

Table 2 I²C Address

I2C address (R/W=0, write)	I2C address (R/W=1, read)
0x50	0x51

4.3 Temperature Maximum Ratings

Thermal specifications for this module have been modeled using a two-layer test board.

Table 3 Temperature Maximum Ratings

Symbol	Definition	Va	Units		
- Cyllibol	Deminion	Min	Max	Onits	
Т	Operating Temperature	-20	80	°C	
Ts	Storage Temperature	-40	100	°C	

4.4 DC Electrical Parameters

DC Electrical specifications for this module have been modeled using a two-layer test board.

Table 4 DC Electrical Specification

Symbol	Definition		Units		
Symbol Deminion		Min	Тур	Max	
V _{BAT}	Power Supply	3.1	3.3	5.5	Volts
I _{VBAT}	DC Current			170	mA



4.5 Antenna Specifications

Antenna specifications for this module have been modeled using a two-layer test board.

Table 5 Antenna Specifications

Item		Value		Unit	Note	
item	Min	Тур	Max	Oilit		
DC	0.5	1	2	Ω		
Resistance	esistance		2		Co	
AC Impedance		50		Ω		
Frequency	13.06	13.56	14.06	MHz	VSWR <2	
Q factor	25	30	35			
Antenna Type	FPC Loop Coil			(0)	Add the Ferrite sheet	
Size	Norma	I: (40 ±0.5) X (5	0±0.5)	mm		

4.6 Power Consumption

Table 6 Current Consumption

Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
I _{HPD}	Hard power down current	V _{BAT} =3.6V, V _{EN} =0V	-	10.5	12	μΑ	
I _{STBY}	Standby state current	V _{BAT} =3.6V	-	-	20	μA	
I _{ACT}	Active state current	V _{BAT} =3.6V	-	6	-	mA	
I _{TVDD}	Transmitter supply current	V _{BAT} =3.1V	-	30	100	mA	
	PMUVCC supply	Class B	-	1.5	3	μΑ	
I _{PMUVCC}		Class C	-	1	2	μΑ	
Sinait							



4.7 Thermal Protection

Table 7 Thermal Protection

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
T _{OVERTEMP}	Temperature protection trigger		120	125	130	°C

4.8 System power modes

Table 8 System Power Modes Description

Mode	Description			
Full power The battery supply (V _{BAT}) as well as the pad supply (VDD_IO) is				
mode	available, all use cases can be executed			
Low-power The pad supply (VDD_IO) is not available. Only the Card Emula				
mode mode use cases via SWP are allowed				
Power Off mode	The system is not supplied from any source or the system is kept Hard			
Fower Off mode	Power Down (HPD)			



Table 9 Power Mode Configuration

V_{BAT}	VDD_IO	V _{EN}	Power mode
Off	Off	X	Power Off mode
On	X	Off	Power Off mode
On	Off	On	Low Power Mode
On	On	On	Full power mode

Note: X: Don't care

4.9 Reset and download concept

To enter reset there are 2 ways:

- Pulling V_{EN} low (Hard Power Down state)
- If V_{BAT} monitor is enabled: lowering V_{BAT} below the monitor threshold (monitor mode, if V_{EN} is kept above 1.1 V)

To get out of reset, there is one way:

Pulling V_{EN} high with V_{BAT} above V_{BAT} monitor threshold if enabled

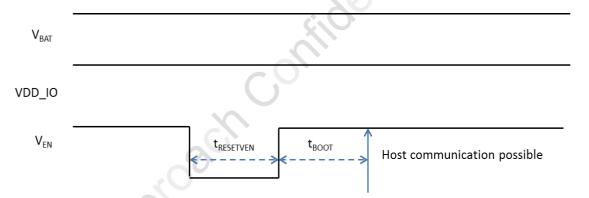


Figure 5 Reset via V_{EN} pin

Table 10 Reset Timing

Symbol	Parameter	Condition	Min	Тур	Max	Unit
t _{RESETVEN}	V_{EN} pulse width to reset		3			μs
t _{BOOT}	Boot time				10	ms



NFC Connection Recommendation

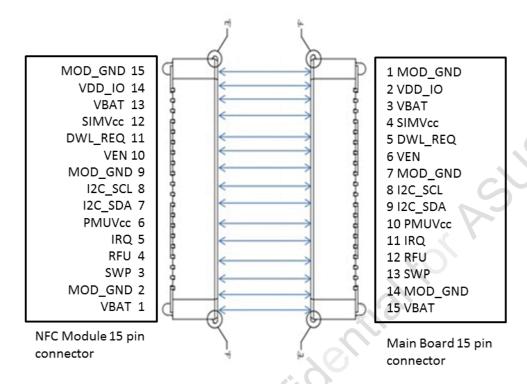


Figure 6 Connection Recommendation

Main Board Design Reference

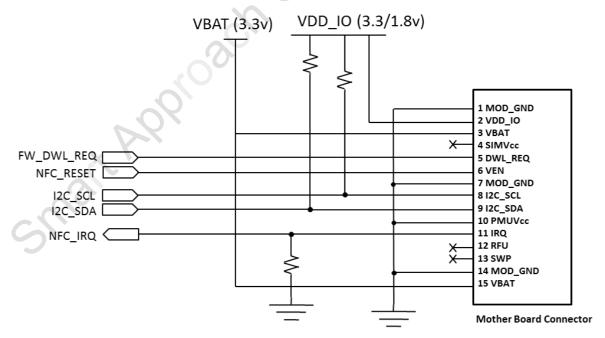


Figure 7 Main Board Design W/O UICC Reference



5 Ordering Information

Table 11 Ordering Information Table

MSN09 NFC Macaron Module (NXP NPC100) with Integrated Antenno Module: 40x50x1.45 mm Module: 40x50x1.45 mm		
* Approach Confidential For ASI	Dimension Module: 40x50x1.45 mm	d Antenna
* Poblogich	·	
* Poblogich		C
* Poblogich		
* Poblogich		
* Poblogich		9
* Poblogich		
* Poblogich	6.0	
* Poblogich		
* Poblogich		
	~ 0X	



6 Reliability Verification

Table 12 Reliability Item Table

No.	Item	Condition	Benchmark	Result	Qty
1	Low Temperature Storage Test	-40°C	IEC60068-2-1	Pass	5
2	High Temperature Storage Test	80°C, Humidity: 95%	IEC60068-2-78	Pass	5
3	Low Temperature Operation Test	-20°C	IEC60068-2-1	Pass	5
4	High Temperature Operation Test	80°C	IEC60068-2-2	Pass	5
5	High Temperature Operation Test	65°C, Humidity: 95%	IEC60068-2-78	Pass	5
6	Salt Test	PH: 3.0 ~ 3.2 ,50°ℂ, 72 hrs, Density: 5%±1%	ASTM B368	Pass	5
7	RoHS	Normal	Compliance	Pass	5
8	HF	Normal	Compliance	Pass	5



7 NFC Module Outline

The following illustration shows the package drawing for MSN09 module. The drawing contains the detail views, dimensions, tolerances, and notes.

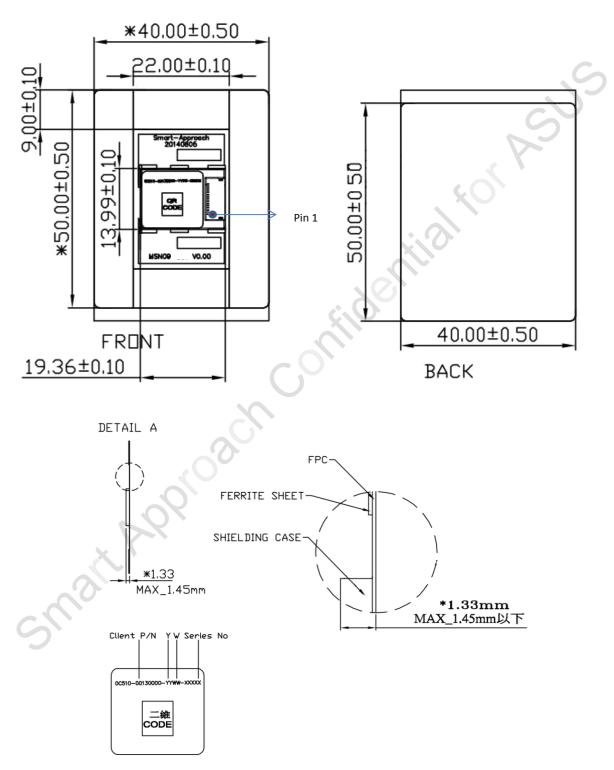


Figure 8 Antenna Module Drawing



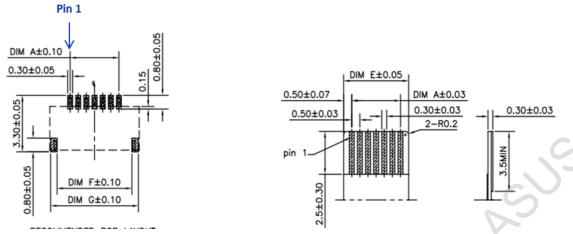


Figure 9 Module FPC Connection Footprint (Button Contact)

CKT	DIM A	DIM B	DIM C	DIM D	DIM E	DIM F	DIM G	DIM H	DIM J	DIM K
10	4.50	7.00	5.57	6.33	5.50	6.10	6.90			
11	5.00	7.50	6.07	6.83	6.00	6.60	7.40	*		
12	5.50	8.00	6.57	7.33	6.50	7.10	7.90			
13	6.00	8.50	7.07	7.83	7.00	7.60	8.40			
14	6.50	9.00	7.57	8.33	7.50	8.10	8.90			
15	7.00	9.50	8.07	8.83	8.00	8.60	9,40			

Figure 10 FPC Wire Dimension

Small



Appendix

Two dimensional bar code rule explanation:

文字及二維條碼打印內容編碼:

0C510-00130000-YYWW-xxxxx

Note

- 1. 前 14 碼固定為客戶料號: 0C510-00130000
- 2. YYWW: YY 為西元年後兩碼,WW 為週數
- 3. xxxxx:為5碼流水序號,從00001至99999



SA 作業程序:

- 1. Barcode Label 打印完成後要以 Reader 百分百全數先讀取, 確認所有條碼都可以正常掃讀.
- 2. 文字打印要清楚,不可以模糊或缺字.
- 3. 需要比對文字與 Barcode 讀取資訊結果正確.
- 4. 條碼標籤標貼位置要與圖面定義位置相符合並避免偏移及歪 Simait Approach 斜.

